

# AMENDMENT TRANSMITTAL LETTER

DGP 1829

ATTORNEY'S DOCKET NO.

00-654

<u>OR</u>

<u>OR</u>

CI	:RI	Δ	in

FILING DATE

EXAMINER

GROUP ART

09/884,736

June 19, 2001

Lisa A. Kilday

UNIT 2829

INVENTION

PLASMA TREATMENT OF LOW DIELECTRIC CONSTANT DIELECTRIC MATERIAL TO FORM STRUCTURES USEFUL IN FORMATION OF METAL INTERCONNECTS AND/OR FILLED VIAS FOR INTEGRATED CIRCUIT STRUCTURE

## TO THE COMMISSIONER OF PATENTS AND TRADEMARKS:

Transmitted herewith is an amendment in the above-identified application.

Small entity status of this application under 37 CAR 1.27 has been established by a verified statement previously submitted.

A verified statement to establish small entity status under 37 CAR 1.9 and 1.27 is enclosed.

No additional fee is required.

X

The fee has been calculated as shown below:

(1)

(2)

(3)

**SMALL ENTITY** 

OTHER THAN A SMALL ENTITY

	CLAIMS REMAINING AFTER AMENDMENT		PREVI	ST NO. OUSLY FOR	PRES EXT	
TOTAL	*	MINUS	**		*	
	17			21		0
INDEP.	*	MINUS	***		*	
	4			3		1
FIRST PRESENTATION OF MULTIPLE DEP. CLAIM						

RATE	ADDIT. FEE
x \$ 9 =	\$
x \$ 42 =	\$
+ \$140 =	\$
TOTAL ADDIT. FEE	\$

RATE		DDIT. FEE	
x \$ 18 =	\$	0	
x \$ 84 =	ų,	84	
+ \$280 =	4	0	
TOTAL	\$	84	

•	If the entry in Col.	1 is less than the	entry in Col. 2,	write "0" in Col. 3

The "Highest No. Previously Paid For" (Total or Indep.) is the highest number found in the appropriate box in Col. 1.

_X	Please charge my Deposit Account No. A duplicate copy of this sheet is enclosed		in the amount of \$	84.00
	A check in the amount of \$		to cover the filing fee is encl	osed.
<u>X</u> _	The Commissioner is hereby authorized overpayment to Deposit Account No.	·	f the following fees associated with this control . A Duplicate copy of this sl	
	Any additional filing fees requi	red under 37 CAR 1	.16.	

Any patent application processing fees under 37 CAR 1.17.

October 31, 2002

(Signature)

<sup>\*\*</sup> If the "Highest No. Previously Paid For" IN THIS SPACE is less than 20, enter "20",

<sup>\*\*\*</sup> If the "Highest No. Previously Paid For" IN THIS SPACE is less than 3, enter "3".

DOCKET NO. 00-654



# TECHNOLOGY CONTEREDON IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

Wilbur G. Catabay and Wei-Jen Hsia

Appl. No.

09/884,736

Filed:

June 19, 2001

Title

PLASMA TREATMENT OF LOW DIELECTRIC DIELECTRIC MATERIAL TO FORM STRUCTURES USEFUL IN

FORMATION OF METAL INTERCONNECTS AND/OR FILLED VIAS

FOR INTEGRATED CIRCUIT STRUCTURE

Grp./ A.U.

2829

Examiner

Lisa A. Kilday

Docket No.

00-654

# **CERTIFICATE OF MAILING**

I hereby certify that this amendment is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on the date

October 31, 2002

(Date of Mailing)

John P. Taylor, Reg. No. 22,369

2002 October 31

Date of Signature

### AMENDMENT

**Honorable Commissioner for Patents** Washington, D.C. 20231

Sir:

Date: October 31, 2002

In response to the Office Action of July 31, 2002, please amend the above-identified application as follows:

돐 84.00

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